

**SINGLE-PHASE GLASS PASSIVATED
MINI SILICON SURFACE MOUNT BRIDGE RECTIFIER**
VOLTAGE RANGE 50 to 1000 Volts CURRENT 0.5 Ampere

FEATURES

- * Surge overload rating - 30 amperes peak
- * Ideal for printed circuit board
- * Reliable low cost construction utilizing molded
- * Glass passivated device
- * Polarity symbols molded on body
- * Mounting position: Any
- * Weight: 0.5 gram

MECHANICAL DATA

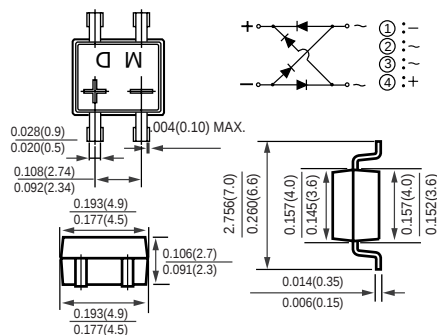
- * Epoxy : Device has UL flammability classification 94V-0
- * UL listed the recognized component directory, file #E94233

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25 °C ambient temperature unless otherwise specified.
Single phase, half wave, 60 Hz, resistive or inductive load.
For capacitive load, derate current by 20%.



MD-S



Dimensions in millimeters

MAXIMUM RATINGS (At $T_A = 25^\circ\text{C}$ unless otherwise noted)

RATINGS	SYMBOL	MD1S	MD2S	MD3S	MD4S	MD5S	MD6S	MD7S	UNITS
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	50	100	200	400	600	800	1000	Volts
Maximum RMS Bridge Input Voltage	V_{RMS}	35	70	140	280	420	560	700	Volts
Maximum DC Blocking Voltage	V_{DC}	50	100	200	400	600	800	1000	Volts
Maximum Average Forward Output Rectified Current at $T_A = 30^\circ\text{C}$ - on glass-epoxy P.C.B. (NOTE 1) - on aluminum substrate (NOTE 2)	I_O	0.5 0.8							Amp
Peak Forward Surge Current 8.3 ms single half sine-wave superimposed on rated load (JEDEC method)	I_{FSM}	30							Amps
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to +150							$^\circ\text{C}$

ELECTRICAL CHARACTERISTICS (At $T_A = 25^\circ\text{C}$ unless otherwise noted)

CHARACTERISTICS	SYMBOL	MD1S	MD2S	MD3S	MD4S	MD5S	MD6S	MD7S	UNITS
Maximum Forward Voltage Drop per Bridge Element at 0.5A DC	V_F	1.05							Volts
Maximum Reverse Current at rated	I_R	10							μAmps
DC Blocking Voltage per element		0.5							mAmps

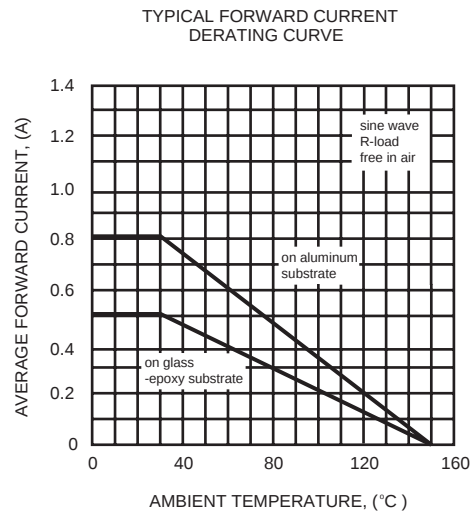
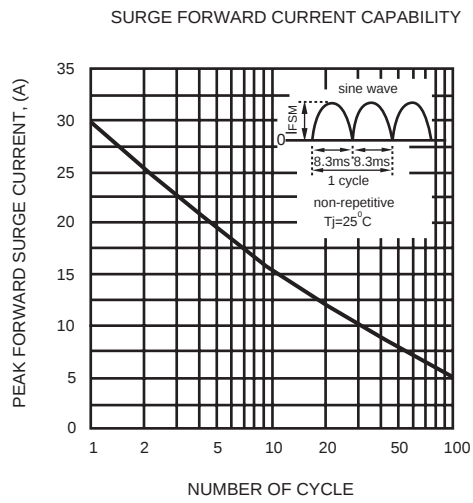
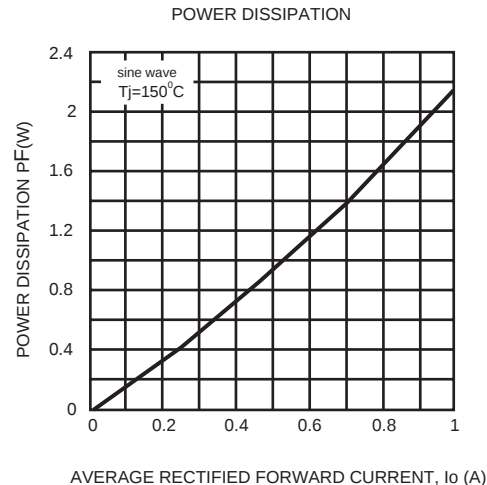
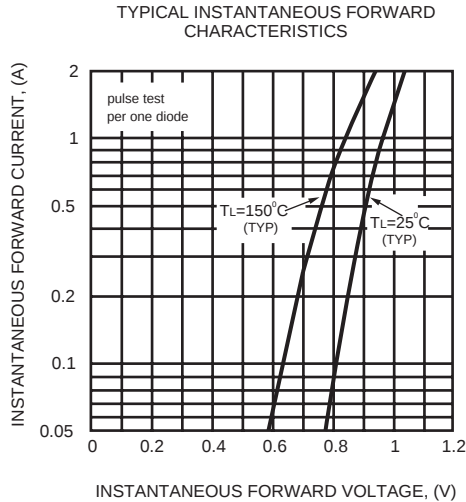
NOTE: 1. On glass-epoxy P.C.B. mounted on 0.05 X 0.05" (1.3 X 1.3mm) pads.

2. On aluminum substrate P.C.B. with an area of 0.8 X 0.8 X 0.25" (20 X 20 X 6.4mm) mounted on 0.05 X 0.05" (1.27 X 1.27mm) solder pad.

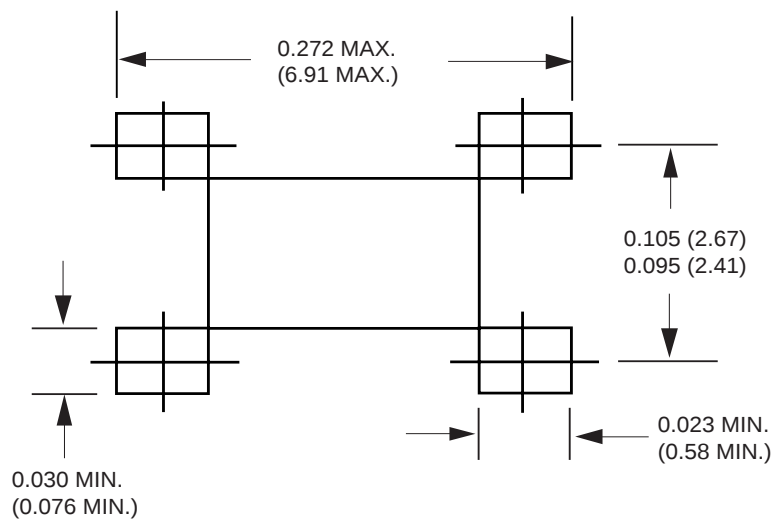
3. Suffix "-S" Surface Mount for Mini Dip Bridge.

2001-4

RATING AND CHARACTERISTIC CURVES (MD1S THRU MD7S)



Mounting Pad Layout



Dimensions in inches and (millimeters)